# 74LVC157A-Q100

## **Quad 2-input multiplexer**

Rev. 3 — 19 March 2020

Product data sheet

### 1. General description

The 74LVC157A-Q100 is a quad 2-input multiplexer which select four bits of data from two sources under the control of a common select input (S). The four outputs present the selected data in the true (non-inverted) form. The enable input (E) is active LOW. When pin E is HIGH, all of the outputs (1Y to 4Y) are forced LOW regardless of all the other input conditions. Moving the data from two groups of registers to four common output buses is a common use of the 74LVC157A-Q100. The state of the common data select input (S) determines the particular register from which the data comes. It can also be used as function generator.

It is useful for implementing highly irregular logic by generating any 4 of the 16 different functions of two variables with one variable common.

The device is the logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to pin S.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and -40 °C to +125 °C
- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- · Direct interface with TTL levels
- Complies with JEDEC standard:
- JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V (C = 200 pF, R = 0 Ω)
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

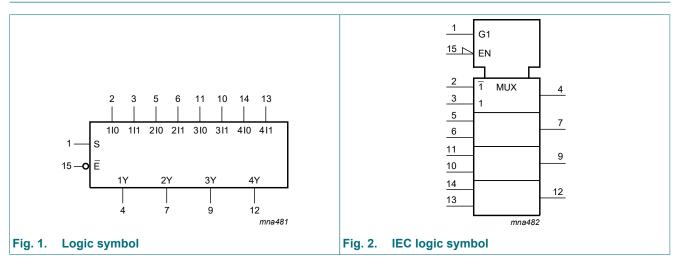


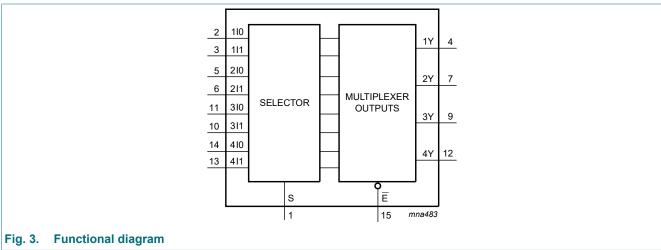
### 3. Ordering information

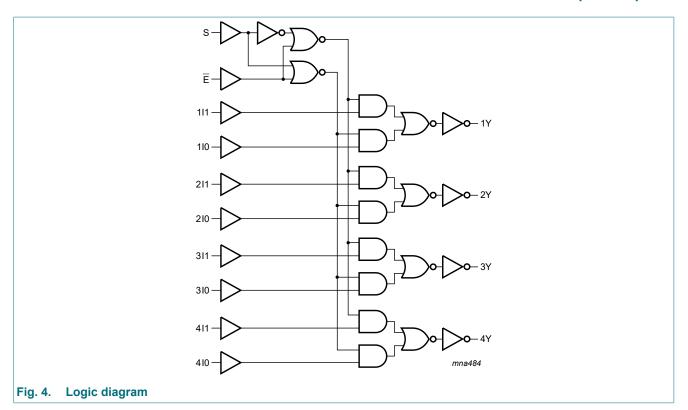
**Table 1. Ordering information** 

Type number	Package									
	Temperature range	Name	Description	Version						
74LVC157AD-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
74LVC157APW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						
74LVC157ABQ-Q100	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1						

### 4. Functional diagram

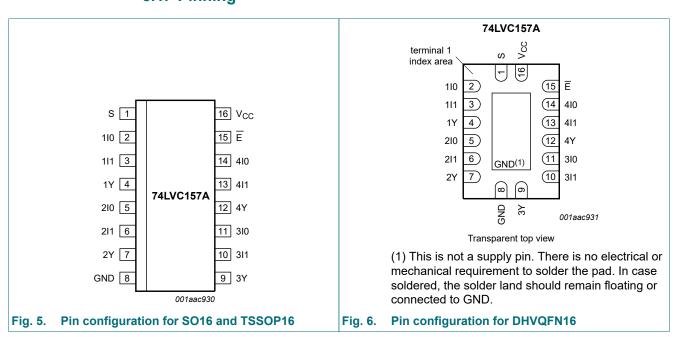






### 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	common data select input
110	2	data input from source 0
111	3	data input from source 1
1Y	4	multiplexer output
210	5	data input from source 0
211	6	data input from source 1
2Y	7	multiplexer output
GND	8	ground (0 V)
3Y	9	multiplexer output
311	10	data input from source 1
310	11	data input from source 0
4Y	12	multiplexer output
411	13	data input from source 1
410	14	data input from source 0
Ē	15	enable input (active LOW)
V <sub>CC</sub>	16	supply voltage

### 6. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care$ 

Input	nput							
Ē	S	nI0	nl1	nY				
Н	Х	X	X	L				
L	L	L	Х	L				
L	L	Н	X	Н				
L	Н	X	L	L				
L	Н	X	Н	Н				

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0		-50	-	mA
V <sub>I</sub>	input voltage		[1]	-0.5	+6.5	V
lok	output clamping current	$V_O > V_{CC}$ or $V_O < 0$		-	±50	mA
Vo	output voltage		[2]	-0.5	V <sub>CC</sub> + 0.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[3]	-	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV input transition rise and fall		V <sub>CC</sub> = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	V <sub>CC</sub> = 2.7 V to 3.6 V	0	-	10	ns/V

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit	
			Min	Typ[1]	Max	Min	Max	1	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V	
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 x V <sub>CC</sub>	-	-	0.65 x V <sub>CC</sub>	-	V	
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V	
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	V	
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>							
	output voltage	output voltage $I_O$ = -100 $\mu$ A; $V_{CC}$ = 1.65 V to 3.6 V		V <sub>CC</sub> - 0.2	-	-	V <sub>CC</sub> - 0.3	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	-	-	1.05	-	V	
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V	1.8	-	-	1.65	-	V	
		$I_O = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>							
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V	
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.65	V	
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V	
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	-	0.6	V	
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	-	0.8	V	
II	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ	
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}$	-	0.1	10	-	40	μΑ	
$\Delta I_{CC}$	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $I_O = 0 \text{ A}$	-	5	500	-	5000	μΑ	
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF	

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

### 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nl0, nl1 to nY; see Fig. 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	16	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.0	4.8	10.2	1.0	11.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	2.8	5.8	1.5	6.7	ns
		V <sub>CC</sub> = 2.7 V		1.0	2.9	5.9	1.0	7.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.5	5.2	1.0	6.5	ns
	E to nY; see Fig. 8	[2]							
		V <sub>CC</sub> = 1.2 V		-	17	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		0.5	4.8	12.8	0.5	14.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	2.8	7.2	1.5	8.3	ns
		V <sub>CC</sub> = 2.7 V		1.0	2.9	7.8	1.0	10.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.6	6.5	1.0	8.5	ns
		S to nY; see Fig. 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	16	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.0	5.1	12.4	1.0	14.3	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	3.0	7.0	1.5	8.1	ns
		V <sub>CC</sub> = 2.7 V		1.0	3.1	7.3	1.0	9.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	2.7	6.3	1.0	8.0	ns
t <sub>sk(o)</sub>	output skew time	V <sub>CC</sub> = 3.0 V to 3.6 V	[3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation	per input; V <sub>I</sub> = GND to V <sub>CC</sub>	[4]						
	capacitance	V <sub>CC</sub> = 1.65 V to 1.95 V		-	9.4	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V		-	12.8	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V		-	15.9	-	-	-	pF

Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

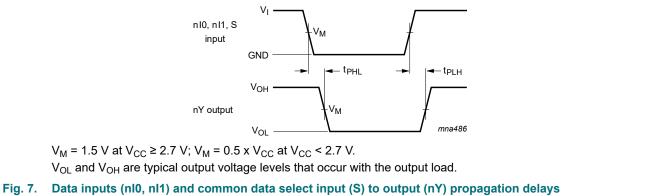
N = number of inputs switching  $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs}$ 

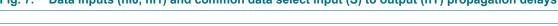
t<sub>pd</sub> is the same as t<sub>pLH</sub> and t<sub>pHL</sub>.

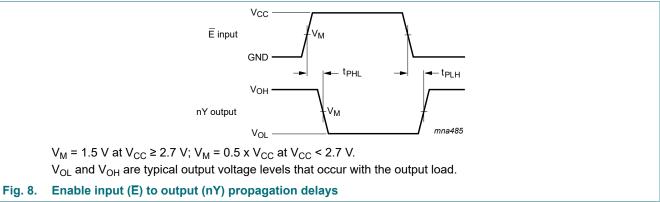
Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

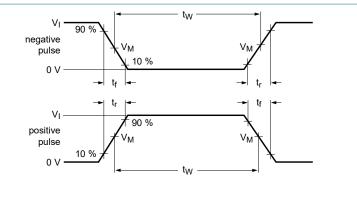
C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

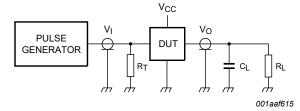
#### 10.1. Waveforms and test circuit











Test data is given in <u>Table 8</u>. Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_{T}$  = Termination resistance should be equal to output impedance  $Z_{\text{o}}$  of the pulse generator.

Fig. 9. Test circuit for measuring switching times

Table 8. Test data

Supply voltage	Input	Input		
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>
1.2 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2 ns	30 pF	500 Ω
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω

### 11. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

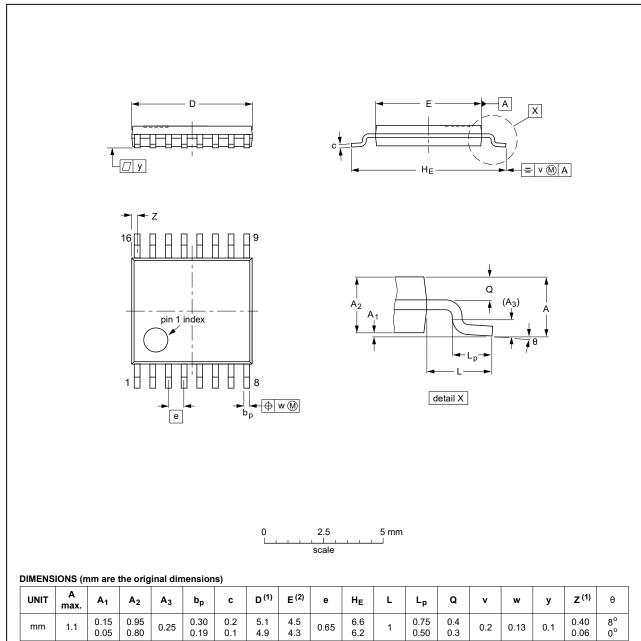
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19	

Fig. 10. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT403-1		MO-153			<del>99-12-27</del> 03-02-18	

Fig. 11. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

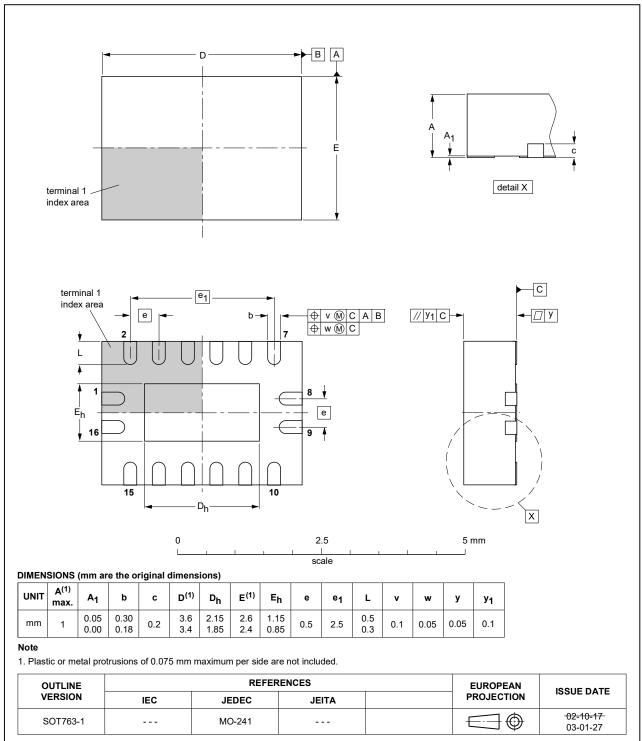


Fig. 12. Package outline SOT763-1 (DHVQFN16)

### 12. Abbreviations

#### **Table 9. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

### 13. Revision history

#### Table 10. Revision history

Tubio To: Itovioloti Illot	o. y			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC157A_Q100 v.3	20200319	Product data sheet	-	74LVC157A_Q100 v.2
Modifications:		ues for P <sub>tot</sub> total power di 157ADB-Q100 removed.	•	
74LVC157A_Q100 v.2	20130502	Product data sheet	-	74LVC157A_Q100 v.1
Modifications:	• 74LVC157ADB-Q10	0 added		
74LVC157A_Q100 v.1	20120807	Product data sheet	-	-

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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